



Part Number : [791077005](#)
Product Description : 2.00mm Pitch Milli-Grid
Receptacle, Vertical, Through Hole, Dual Row, 3.00mm
Tail Length, 0.38µm Gold (Au) Selective Plating, 12
Circuits, Lead-Free
Series Number : 79107
Status : Active
Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings

[791077005 sd.pdf](#)
[PK-70873-0180-001.pdf](#)

3D Models and Design Files

[791077005 stp.zip](#)

Specifications

[503940001-AS-000.pdf](#)
[PS-79107-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)7663-DC (21 Jan 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	79107
Description	2.00mm Pitch Milli-Grid Receptacle, Vertical, Through Hole, Dual Row, 3.00mm Tail Length, 0.38µm Gold (Au) Selective Plating, 12 Circuits, Lead-Free
Application	Board-to-Board, Signal
Component Type	PCB Receptacle
Product Name	Milli-Grid
UPC	822348474509

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	125V

Physical

Circuits (Loaded)	12
Circuits (maximum)	12

Color - Resin	Black
Durability (mating cycles max)	50
Flammability	94V-0
Glow-Wire Capable	No
Lock to Mating Part	None
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.343/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tube
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
PC Tail Length	3.00mm
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to Mating Part	No
Polarized to PCB	No
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	10
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
Milli-Grid Vertical Through Hole Headers	<u>87758</u>
Milli-Grid Vertical Surface Mount Headers	<u>87759</u>
Milli-Grid Right-Angle Through Hole Headers	<u>87760</u>
Milli-Grid Vertical, Dual Row, Through Hole Headers	<u>87831</u>
Milli-Grid Vertical, Dual Row, Surface Mount Headers	<u>87832</u>
Milli-Grid Vertical, Dual Row, Through Hole Headers	<u>151117</u>
Milli-Grid Vertical, Dual Row, Surface Mount Headers	<u>151118</u>
Milli-Grid Right-Angle, Dual Row, Through Hole Headers	<u>151119</u>
Milli-Grid Right-Angle, Dual Row, Surface Mount Headers	<u>151120</u>